ABSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INCLUSTRIES	C. Bannockl	burn. Illinois. A	ll rights reserved utions.	under both	This docume level parts, t	ent is a declaration e	on of the su	ibstances s all lower	within the manufate level materials for	cturer listed r which the	l item. Note manufactu	: if the item is an a rer has engineering	ssembly with lowe responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form http://www.ipc.org/IPC-175x Distr				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					terials and	als and Mfg Information			
Supplier Information														
Company name*		Company uni	Company unique ID			Unique ID Authority					Response Date*			
nsemi							,				2024-04-30			
Contact Name	act Name Title - Contact			Ţ			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product E			act Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Re			e - Representative			Phone - Representative*				Email	Email - Representative*			
Product-Env-Stewards Pro			Product Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	NCV890 G	NCV890430MW33TX Auton G		Automotive Switcher		2024-04-30		N	MY1		23.83	mg	Each	
Manufacturing Proccess Informat	ion													
Terminal Plating / Grid Array Ma	terial 7	Ferminal Base A	Alloy J-STD-020 MSL Ra		L Rating	Peak Proc	ess Body To	Temperature Max Time at Pea		eak Temper	Temperature Number of Reflow Cycles			
Matte Tin (Sn) - annealed CU Alloy		CU Alloy	1			260	260 C 30		sec	seconds 3				
comments														
evel 1 - maximum time at peak temperatu	re during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	oHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead b), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl thalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measur
Die	1.94	mg	Supplier	Silicon (Si)	7440-21-3		1.94	mg
Die Attach	0.29	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.0174	mg
			Supplier	Silver (Ag)	7440-22-4		0.2363	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0174	mg
			Supplier	Misc.	Proprietary Data		0.0014	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.0174	mg
Lead Frame 9	9.25	mg	Supplier	Tin (Sn)	7440-31-5		0.0231	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0203	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0231	mg
			Supplier	Copper (Cu)	7440-50-8		9.1834	mg
Lead Frame plating	0.19	mg	Supplier	Silver (Ag)	7440-22-4		0.19	mg
Mold Compound-Black	11.03	mg		Epoxy resin	proprietary data		0.5184	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1.103	mg
			Supplier	Carbon Black (C)	1333-86-4		0.011	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		8.8791	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.5184	mg
Plating	0.75	mg	Supplier	Tin (Sn)	7440-31-5		0.75	mg
Wire Bond - Au	0.38	mg	Supplier	Gold (Au)	7440-57-5		0.38	mg